TSCDT16065G1 Taiwan Semiconductor

16A, 650V SiC Merged PIN Schottky Diode

FEATURES

- Max junction temperature 175°C
- MPS structure for high ruggedness to forward current surge events
- High-speed switching possible
- High forward surge capability
- High-frequency operation
- Positive temperature coefficient on V_F
- RoHS compliant
- Halogen-free

APPLICATIONS

- General purpose
- Switch mode power supplies
- Power factor correction

MECHANICAL DATA

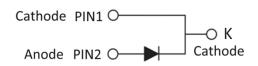
- Case: TO-220AC-2L
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Polarity: As circuit diagram
- Weight: 2.03g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
lf	16	А		
V _{RRM}	650	V		
I _{FSM}	100	А		
T _{J MAX}	175	°C		
Package	TO-220AC-2L			
Configuration	Single die			









ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)					
PARAMETER		SYMBOL	VALUE	UNIT	
Repetitive peak reverse voltage		Vrrm	650	V	
Reverse voltage, total rms value		V _{R(RMS)}	455	V	
Continuous Rectified Forward Current @ TJ = 149°C		lF	16	А	
Surge peak forward current 10ms single half sine-wave superimposed on rated load	$T_C = 25^{\circ}C$		100	А	
	Tc = 125°C	IFSM	80	А	
Junction temperature		TJ	-55 to +175	°C	
Storage temperature		T _{STG}	-55 to +175	°C	





THERMAL PERFORMANCE				
PARAMETER	SYMBOL	ТҮР	MAX	UNIT
Junction-to-case thermal resistance	R _{ejc}	0.98	1.18	°C/W

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage ⁽¹⁾	$I_F = 8A, T_J = 25^{\circ}C$	VF	1.16	-	V
	I _F = 16A, T _J = 25°C		1.38	1.45	V
	$I_F = 8A, T_J = 150^{\circ}C$		1.21	-	V
	$I_F = 16A, T_J = 150^{\circ}C$		1.60	-	V
	I⊧ = 8A, T」 = 175°C		1.23	-	V
	I⊧ = 16A, TJ = 175°C		1.68	1.85	V
Reverse current @ rated $V_{R}^{(2)}$	T _J = 25°C	I _R	-	20	μA
	T _J = 175°C		-	200	μA
Junction capacitance	$f = 1MHz, V_R = 1V$	CJ	638	-	pF
	$f = 1MHz, V_R = 200V$		100	-	pF
	$f = 1MHz, V_R = 400V$		70	-	pF
Capacitive Charge	V _R = 400V	Qc	49	-	nC

Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE	PACKAGE	PACKING		
TSCDT16065G1	TO-220AC-2L	50 / Tube		



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

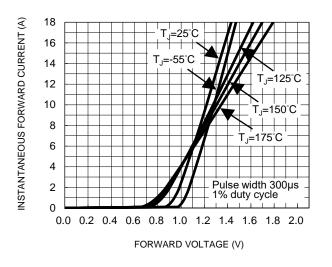
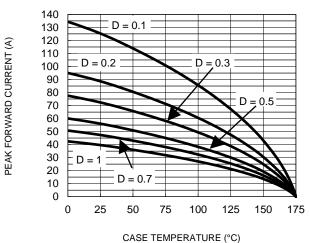
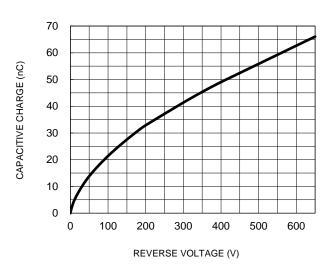


Fig.1 Typical Forward Characteristics

Fig.3 Peak forward current versus case temperature







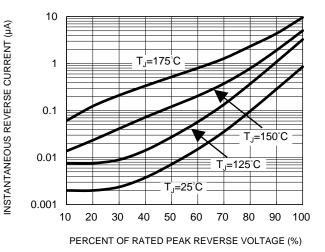


Fig.2 Typical Reverse Characteristics

Fig.4 Typical Junction Capacitance

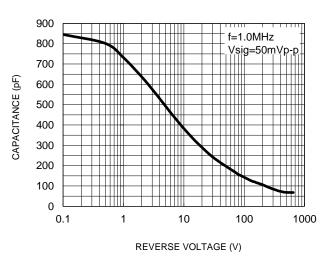
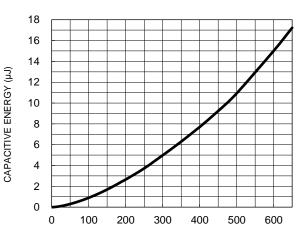


FIG.6 Typical Capacitance Stored Energy



REVERSE VOLTAGE (V)



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

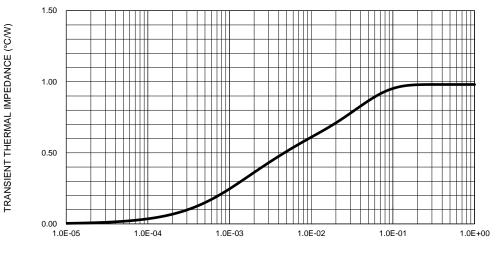


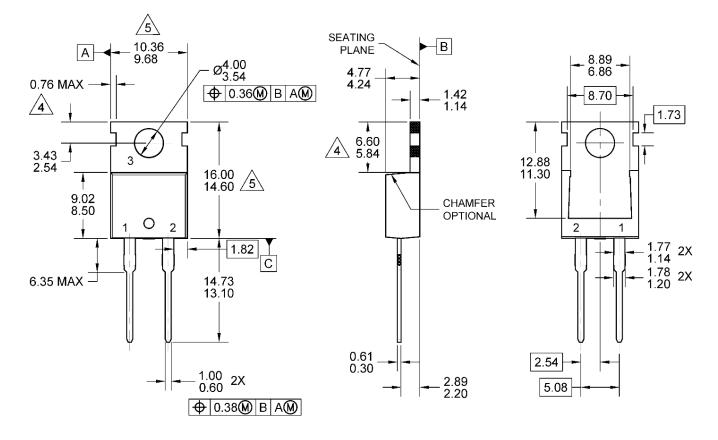
Fig.7 Typical Transient Thermal Characteristics

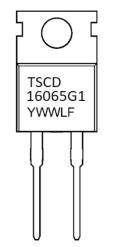
PULSE DURATION (s)



PACKAGE OUTLINE DIMENSIONS







MARKING DIAGRAM

- Y = YEAR CODE
- WWW = WEEK CODE (01~52)
- L = LOT CODE (1~9, A~Z)
- F = FACTORY CODE

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC TO-220, VARIATION AC, ISSUE K.
- 4 THE DEFINED ZONE WHERE STAMPING AND SINGULATION IRREGULARITIES ARE ALLOWED. SLOT AND NOTCH MAY APPEAR IN THIS ZONE.
- 5 THIS DO NOT INCLUDE MOLD FLASH. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREME OF THE PLASTIC BODY.
- 6. DWG NO REF: HQ2SD07-TO220ACSiC-119 REV A.



TSCDT16065G1

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